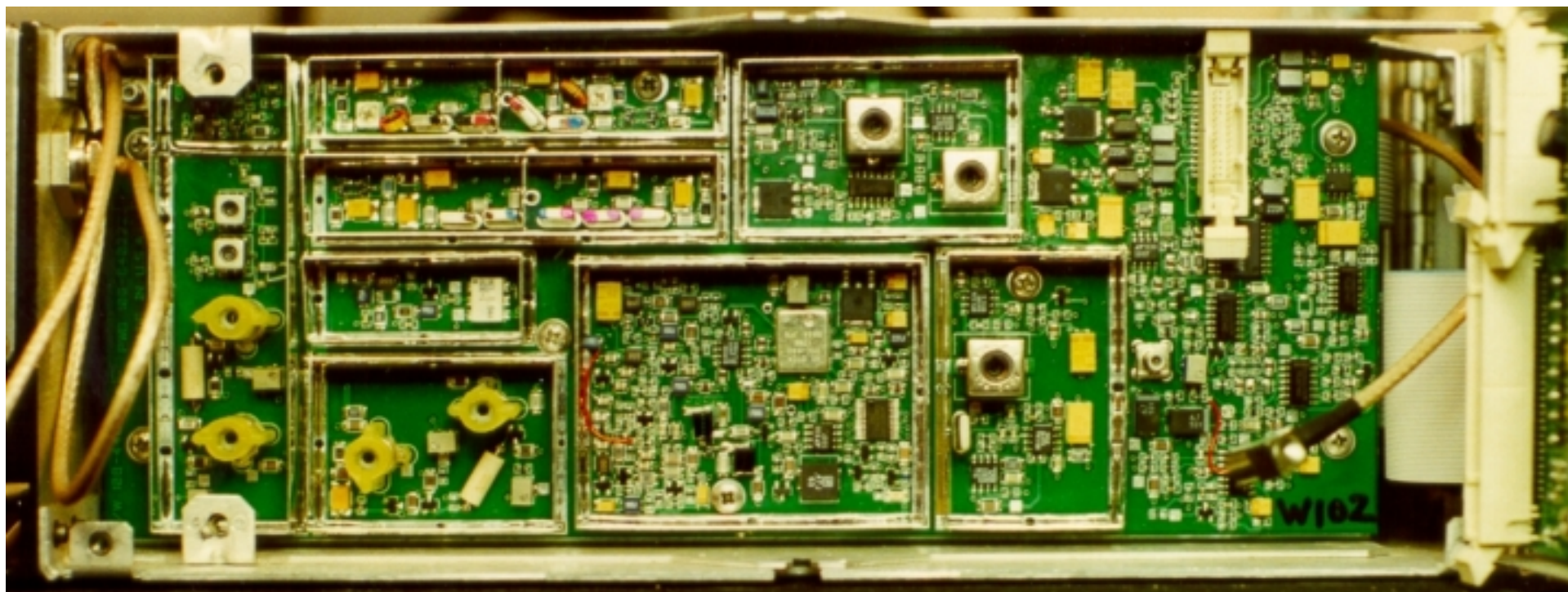


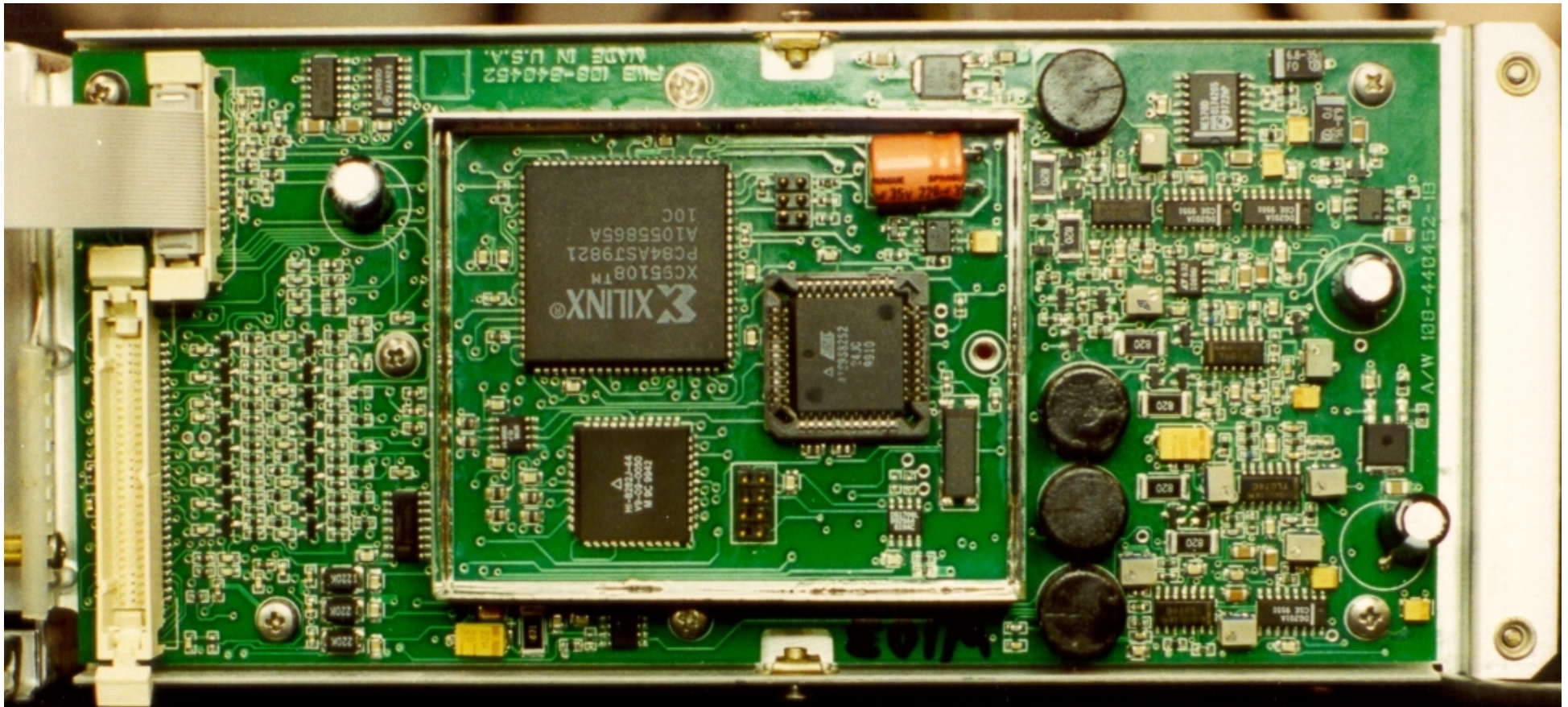
## 1.1 Synthesizer and Receiver board.

Only three surface mount resistors are mounted on the backside. They act as heating elements for the TCXO chamber. This photo is taken with eight shield covers removed to show parts. The shield walls are visible.



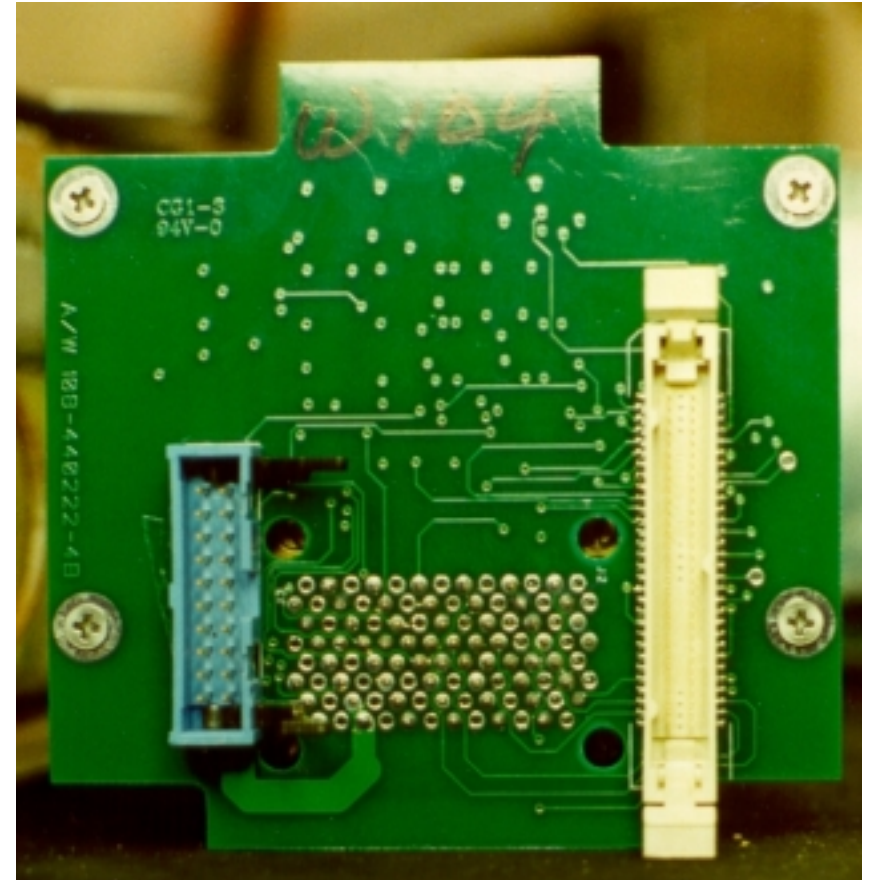
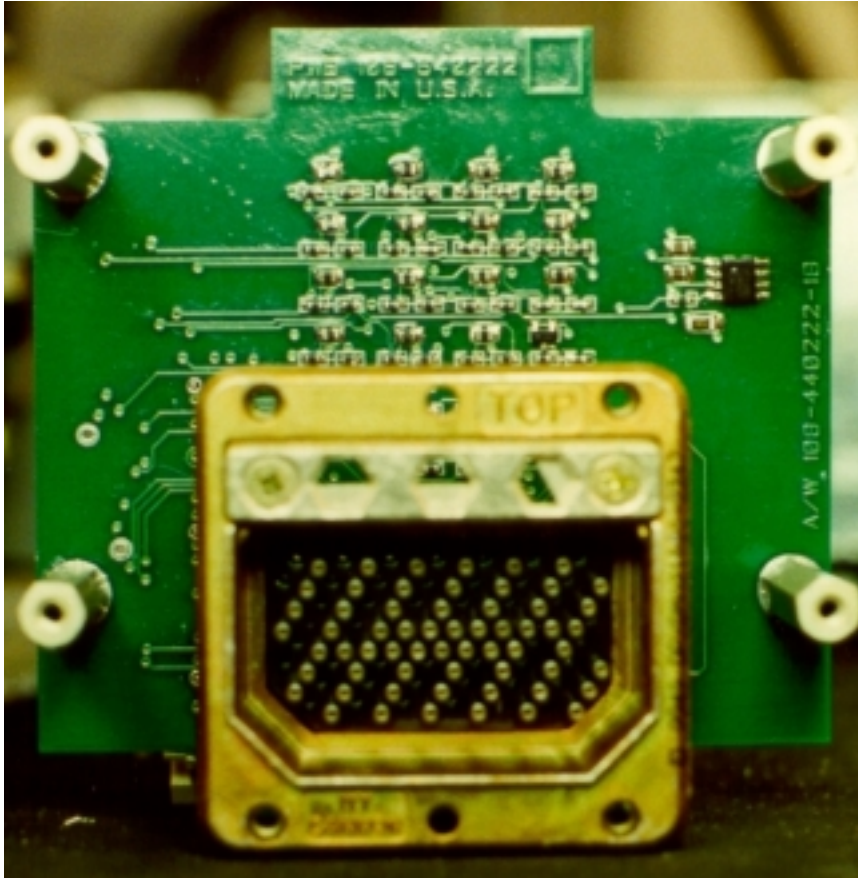
## 1.2 Audio and Microcontroller Board

No parts are on the backside of this board. Photo taken with center shield cover removed.



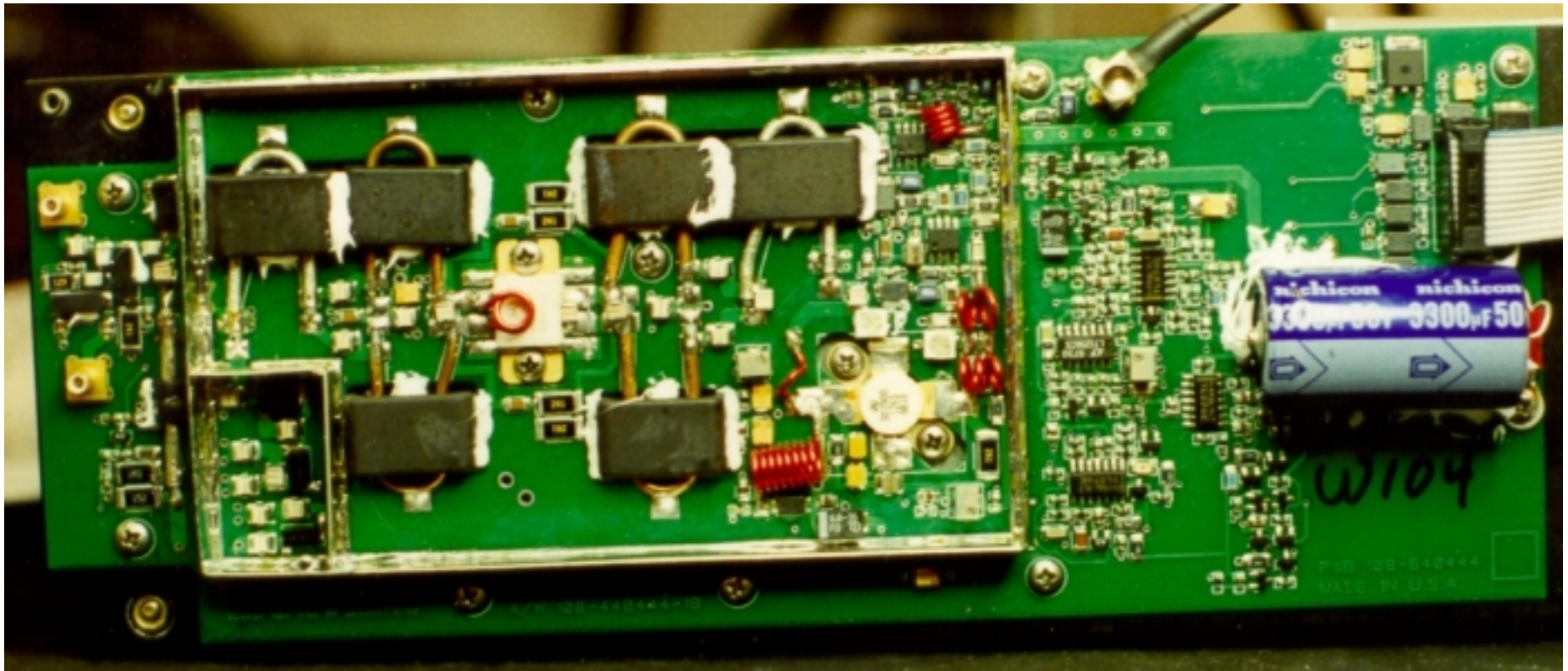
### 1.3 H & L Interconnect Board

Front and backsides are shown.



## 1.4 Power Amplifier Board.

No parts are located on the backside of this board. This board is directly mounted to the heat sink, which forms part of the outside cover. This board has one shield cover, which is removed for this picture.



## 1.5 Power Supply Board.

No parts are located on the backside of this board.

